Product specification

BUK127-50GT

DESCRIPTION

Monolithic temperature and overload protected logic level power MOSFET in **TOPFET2** technology assembled in a 3 pin surface mount plastic package.

APPLICATIONS

General purpose switch for driving

- lamps
- motors
- solenoids
- heaters

in automotive systems and other applications.

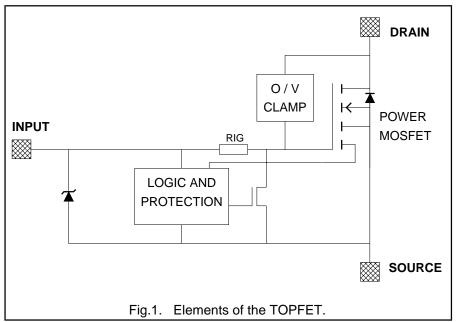
FEATURES

- TrenchMOS output stage
- Current trip protection
- Overload protection
- Overtemperature protection
- Protection latched reset by input
- 5 V logic compatible input level
 Control of output stage and supply of overload protection circuits
- derived from input
 Low operating input current permits direct drive by micro-controller
- ESD protection on all pins
- Overvoltage clamping for turn off of inductive loads

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{DS}	Continuous drain source voltage	50	V
I _D	Continuous drain current	2.1	А
P _D	Total power dissipation	1.8	W
T _j	Continuous junction temperature	150	°C
R _{DS(ON)}	Drain-source on-state resistance	200	mΩ

FUNCTIONAL BLOCK DIAGRAM



PINNING - SOT223

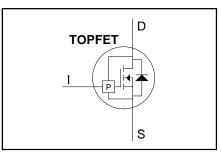
PIN	DESCRIPTION
1	input
2	drain
3	source
4	drain (tab)

PIN CONFIGURATION

1

4

SYMBOL



2

3

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LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{DS}	Continuous drain source voltage ¹	-	-	50	V
I _D	Drain current ²	-	-	current trip	A
I _D	Continuous drain current	$T_a = 25^{\circ}C$	-	2.1	A
I,	Continuous input current	clamping	-	3	mA
I _{IRM}	Non-repetitive peak input current	$t_n \le 1 \text{ ms}$	-	10	mA
P _D	Total power dissipation	T _a = 25 °C	-	1.8	W
T _{stg}	Storage temperature	-	-55	150	°C
Tj	Continuous junction temperature	normal operation ³	-	150	°C

ESD LIMITING VALUE

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _c	Electrostatic discharge capacitor voltage	Human body model; C = 250 pF; R = 1.5 k Ω	-	2	kV

OVERVOLTAGE CLAMPING LIMITING VALUES

At a drain source voltage above 50 V the power MOSFET is actively turned on to clamp overvoltage transients.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
E _{DSM}	Non-repetitive clamping energy	$T_a \le 25 \ ^\circ C; \ I_{DM} \le I_{D(TO)};$	-	100	mJ
E _{DRM}	Repetitive clamping energy	inductive load $T_{sp} \le 125$ °C; $I_{DM} = 1$ A; f = 250 Hz	-	5	mJ

OVERLOAD PROTECTION LIMITING VALUES

With the protection supply provided via the input pin, TOPFET can protect itself from short circuit loads. Overload protection operates by means of drain current trip or by activating the overtemperature protection.

SYMBOL	PARAMETER	REQUIRED CONDITION	MIN.	MAX.	UNIT
V _{DDP}	Protected drain source supply voltage	$V_{IS} \ge 4 V$	-	35	V

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-sp} R _{th j-b} R _{th j-a}	Thermal resistance Junction to solder point Junction to board ⁴ Junction to ambient	Mounted on any PCB Mounted on PCB of fig. 4		12 40 -	18 - 70	K/W K/W K/W

¹ Prior to the onset of overvoltage clamping. For voltages above this value, safe operation is limited by the overvoltage clamping energy.

² Refer to OVERLOAD PROTECTION CHARACTERISTICS.

³ Not in an overload condition with drain current limiting.

⁴ Temperature measured 1.3 mm from tab.

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OUTPUT CHARACTERISTICS

Limits are for -40°C \leq T_{mb} \leq 150°C; typicals are for T_{mb} = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
	Off-state	$V_{IS} = 0 V$				
V _{(CL)DSS}	Drain-source clamping voltage	I _D = 10 mA	50	-	-	V
		$I_{\text{D}} = 200 \text{ mA}; t_{\text{p}} \leq 300 \mu\text{s}; \delta \leq 0.01$	50	60	70	V
I _{DSS}	Drain source leakage current	$V_{DS} = 40 V$	-	-	100	μA
		$T_{mb} = 25 \degree C$	-	0.1	10	μΑ
	On-state	$V_{IS} \ge 4 \text{ V}; t_p \le 300 \ \mu\text{s}; \ \delta \le 0.01$				
R _{DS(ON)}	Drain-source resistance	I _D = 100 mA	-	-	380	mΩ
		T _{mb} = 25 °C	-	150	200	mΩ

INPUT CHARACTERISTICS

The supply for the logic and overload protection is taken from the input. Limits are for -40°C $\leq T_{mb} \leq 150$ °C; typicals are for $T_{mb} = 25$ °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS		MIN.	TYP.	MAX.	UNIT
V _{IS(TO)}	Input threshold voltage	$V_{DS} = 5 V; I_{D} = 1 mA$	T _{mb} = 25°C	0.6 1.1	- 1.6	2.4 2.1	V V
I _{IS}	Input supply current	normal operation;	V _{IS} = 5 V V _{IS} = 4 V	100 80	220 195	400 330	μΑ μΑ
I _{ISL}	Input supply current	protection latched;	V _{IS} = 5 V V _{IS} = 3 V	1.4 0.7	2 1.1	2.5 1.5	mA mA
V _{ISR}	Protection reset voltage ¹	reset time $t_r \ge 100 \ \mu s$		1.5	2	2.5	V
t _{ir}	Latch reset time	$V_{IS1} = 5 V, V_{IS2} < 1 V$		10	40	100	μs
V _{(CL)IS}	Input clamping voltage	l _i = 1.5 mA		5.5	-	8.5	V
R _{IG}	Input series resistance ² to gate of power MOSFET		$T_{mb} = 25^{\circ}C$	-	2.5	-	kΩ

OVERLOAD PROTECTION CHARACTERISTICS

TOPFET switches off to protect itself when one of the overload thresholds is exceeded. It remains latched off until reset by the input.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
	Overload protection	$V_{IS} = 4 V \text{ to } 5.5 V$				
I _{D(TO)}	Drain current trip threshold	$T_j = 25^{\circ}C$	4	-	8	А
		$-40^{\circ}C \le T_{j} \le 150^{\circ}C$	3	-	9	А
	Overtemperature protection					
T _{j(TO)}	Threshold junction temperature	$V_{IS} = 4 V \text{ to } 5.5 V$	150	170	-	°C

¹ The input voltage below which the overload protection circuits will be reset.

² Not directly measureable from device terminals.

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SWITCHING CHARACTERISTICS

 $T_a = 25$ °C; resistive load $R_L = 50 \Omega$; adjust V_{DD} to obtain $I_D = 250$ mA; refer to test circuit and waveforms

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
t _{d on}	Turn-on delay time	$V_{IS} = 0 V \text{ to } V_{IS} = 5 V$	-	0.5	0.9	μs
t,	Rise time		-	0.7	1.5	μs
t _{d off}	Turn-off delay time	$V_{IS} = 5 V \text{ to } V_{IS} = 0 V$	-	3.2	6.5	μs
t _f	Fall time		-	1.6	3.5	μs

REVERSE DIODE LIMITING VALUE

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I _s	Continuous forward current	$T_{mb} \leq 25$ °C; $V_{IS} = 0$ V	-	2	А

REVERSE DIODE CHARACTERISTICS

Limits are for -40°C \leq T_{mb} \leq 150°C; typicals are for T_{mb} = 25°C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{SDO}	Forward voltage	$I_{s} = 2 \text{ A}; V_{1s} = 0 \text{ V}; t_{p} = 300 \ \mu \text{s}$	-	0.83	1.1	V
t _{rr}	Reverse recovery time	not applicable ¹	-	-	-	-

¹ The reverse diode of this type is not intended for applications requiring fast reverse recovery.

Product specification

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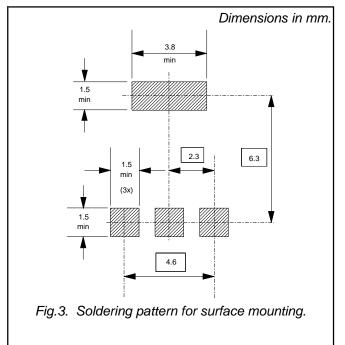
MECHANICAL DATA

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	1.5	0.01	0.60	2.9	0.22	6.3	3.3			6.7	0.7	0.85					
OL	TLINE						RE	FEREN	CES					E	UROPI	AN	
VERSION			IEC			JEDEC			EIAJ						ROJEC	TION	ISSUE DATE
SOT223									SC-	73				$= \bigcirc$			97-02-28 99-09-13

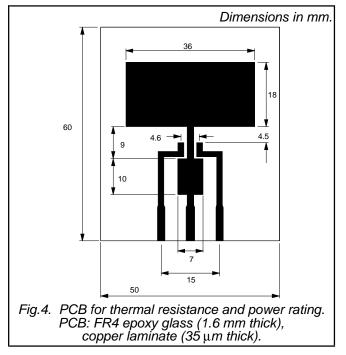
¹ For further information, refer to surface mounting instructions for SOT223 envelope. Epoxy meets UL94 V0 at 1/8". Net Mass: 0.11 g

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MOUNTING INSTRUCTIONS



PRINTED CIRCUIT BOARD



BUK127-50GT

DEFINITIONS

DATA SHEET STATUS							
DATA SHEET STATUS ¹	PRODUCT STATUS ²	DEFINITIONS					
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice					
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product					
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A					

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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¹ Please consult the most recently issued datasheet before initiating or completing a design.

² The product status of the device(s) described in this datasheet may have changed since this datasheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.